

## **General Description**

The MAX4245/MAX4246/MAX4247 family of low-cost op amps offer rail-to-rail inputs and outputs, draw only 320µA of guiescent current, and operate from a single +2.5V to +5.5V supply. For additional power conservation, the MAX4245/MAX4247 offer a low-power shutdown mode that reduces supply current to 50nA, and puts the amplifiers' outputs in a high-impedance state. These devices are unity-gain stable with a 1MHz gain-bandwidth product driving capacitive loads up to 470pF.

The MAX4245/MAX4246/MAX4247 family is specified from -40°C to +125°C, making them suitable for use in a variety of harsh environments, such as automotive applications. The MAX4245 single amplifier is available in ultra-small 6-pin SC70 and space-saving 6-pin SOT23 packages. The MAX4246 dual amplifier is available in 8-pin SOT23, SO, and µMAX® packages. The MAX4247 dual amplifier comes in a tiny 10-pin µMAX package.

## **Applications**

Portable Communications

Single-Supply Zero-Crossing Detectors

Instruments and Terminals

Electronic Ignition Modules

Infrared Receivers

Sensor-Signal Detection

### **Features**

- ♦ Rail-to-Rail Input and Output Voltage Swing
- ♦ 50nA (max) Shutdown Mode (MAX4245/MAX4247)
- ♦ 320µA (typ) Quiescent Current Per Amplifier
- ♦ Single +2.5V to +5.5V Supply Voltage Range
- ♦ 110dB Open-Loop Gain with 2kΩ Load
- ♦ 0.01% THD with 100k $\Omega$  Load
- ♦ Unity-Gain Stable up to C<sub>LOAD</sub> = 470pF
- ♦ No Phase Inversion for Overdriven Inputs
- **♦** Available in Space-Saving Packages 6-Pin SC70 or 6-Pin SOT23 (MAX4245) 8-Pin SOT23/SO or 8-Pin µMAX (MAX4246) 10-Pin μMAX (MAX4247)

### **Ordering Information**

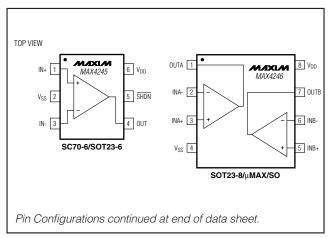
PART	TEMP RANGE	PIN- PACKAGE	TOP MARK
MAX4245AXT-T	-40°C to +125°C	6 SC70-6	AAZ
MAX4245AUT-T	-40°C to +125°C	6 SOT23-6	AAUB
MAX4246AKA-T	-40°C to +125°C	8 SOT23-8	AAIN
MAX4246ASA	-40°C to +125°C	8 SO	_
MAX4246AUA	-40°C to +125°C	8 µMAX	_
MAX4247AUB	-40°C to +125°C	10 μMAX	_

#### **Selector Guide**

PART	AMPLIFIERS PER PACKAGE	SHUTDOWN MODE
MAX4245AXT-T	1	Yes
MAX4245AUT-T	1	Yes
MAX4246AKA-T	2	No
MAX4246ASA	2	No
MAX4246AUA	2	No
MAX4247AUB	2	Yes

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## Pin Configurations



MIXIM

Maxim Integrated Products 1

For pricing, delivery, and ordering information, please contact Maxim/Dallas Direct! at 1-888-629-4642, or visit Maxim's website at www.maxim-ic.com.

### **ABSOLUTE MAXIMUM RATINGS**

Power-Supply Voltage (V <sub>DD</sub> to V <sub>SS</sub> )0.3V to +6V All Other Pins(V <sub>SS</sub> - 0.3V) to (V <sub>DD</sub> + 0.3V) Output Short-Circuit Duration	
(OUT shorted to V <sub>SS</sub> or V <sub>DD</sub> ) Continuous	
Continuous Power Dissipation (T <sub>A</sub> = +70°C) 6-Pin SC70 (derate 3.1mW/°C above +70°C)245mW	
6-Pin SOT23 (derate 8.7mW/°C above +70°C)695mW 8-Pin SO (derate 5.9mW/°C above +70°C)471mW	

8-Pin SOT23 (derate 9.1mW/°C above +70°C)	727mW
8-Pin µMAX (derate 4.5mW/°C above +70°C)	362mW
10-Pin µMAX (derate 5.6mW/°C above +70°C)	444mW
Operating Temperature Range40°C to	+125°C
Junction Temperature	+150°C
Storage Temperature Range65°C to	+160°C
Lead Temperature (soldering, 10s)	+300°C

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

### **ELECTRICAL CHARACTERISTICS**

 $(V_{DD} = +2.7V, V_{SS} = 0V, V_{CM} = 0V, V_{OUT} = V_{DD} / 2, R_L \text{ connected from OUT to } V_{DD} / 2, \overline{SHDN} = V_{DD} \text{ (MAX4245/MAX4247 only), } T_A = +25^{\circ}C, \text{ unless otherwise noted.)} \text{ (Note 1)}$ 

PARAMETER	SYMBOL	CONDITIONS		MIN	TYP	MAX	UNITS
Supply Voltage Range	$V_{DD}$	Inferred from PSRR test		2.5		5.5	V
Complet Comment (Day Amendifica)	1	$V_{DD} = +2.7V$			320	650	
Supply Current (Per Amplifier)	IDD	$V_{DD} = +5.5V$			375	700	μΑ
Supply Current in Shutdown	ISHDN_	SHDN_ = V <sub>SS</sub> (Not	te 2)		0.05	0.5	μΑ
Input Offset Voltage	Vos	$V_{SS}$ - 0.1 $V \le V_{CM} \le$	≤ V <sub>DD</sub> + 0.1V		±0.4	±1.5	mV
Input Bias Current	ΙΒ	V <sub>SS</sub> - 0.1V ≤ V <sub>CM</sub> ≤	≤ V <sub>DD</sub> + 0.1V		±10	±50	nA
Input Offset Current	los	V <sub>SS</sub> - 0.1V ≤ V <sub>CM</sub> ≤	≤ V <sub>DD</sub> + 0.1V		±1	±6	nA
Input Resistance	RIN	$ V_{IN+} - V_{IN-}  \le 10$ m	V		4000		kΩ
Input Common-Mode Voltage Range	V <sub>CM</sub>	Inferred from CMR	R test	V <sub>SS</sub> - 0.1		V <sub>DD</sub> + 0.1	V
Common-Mode Rejection Ratio	CMRR	V <sub>SS</sub> - 0.1V ≤ V <sub>CM</sub> ≤	≤ V <sub>DD</sub> + 0.1V	65	80		dB
Power-Supply Rejection Ratio	PSRR	$2.5V \le V_{DD} \le 5.5V$		75	90		dB
Large-Signal Voltage Gain	Av	$V_{SS} + 0.05V \le V_{OUT} \le V_{DD} - 0.05V$ , $R_L = 100k\Omega$			120		dB
		$V_{SS} + 0.2V \le V_{OUT} \le V_{DD} - 0.2V$ , $R_L = 2k\Omega$		95	110		
Outrout Valta are Outro at High		Specified as $R_L = 100k\Omega$			1		mV
Output Voltage Swing High	V <sub>OH</sub>	V <sub>DD</sub> - V <sub>OUT</sub>	$R_L = 2k\Omega$		35	60	mv
Output Voltage Swing Low	\/a	Specified as $R_L = 100k\Omega$			1		mV
Output Voltage Swing Low	VoL	V <sub>OUT</sub> - V <sub>SS</sub>	$R_L = 2k\Omega$		30	60	IIIV
Output Short Circuit Current	1	$V_{DD} = +5.0V$ Sourcing Sinking	Sourcing		11		mA
Output Short-Circuit Current	1001(SC)		Sinking		30		MA
Output Leakage Current in Shutdown	IOUT(SH)	Device in Shutdown Mode (SHDN_ = V <sub>SS</sub> ), V <sub>SS</sub> ≤ V <sub>OUT</sub> ≤ V <sub>DD</sub> (Note 2)			±0.01	±0.5	μΑ
SHDN_ Logic Low	V <sub>IL</sub>	(Note 2)			(	0.3 x V <sub>DD</sub>	V
SHDN_ Logic High	VIH	(Note 2)		0.7 x V <sub>DD</sub>			V
SHDN_ Input Current	I∟/I <sub>H</sub>	V <sub>SS</sub> ≤ SHDN_ ≤ V <sub>DD</sub> (Note 2)			0.5	50	nA

## **ELECTRICAL CHARACTERISTICS (continued)**

 $(V_{DD} = +2.7V, V_{SS} = 0V, V_{CM} = 0V, V_{OUT} = V_{DD} / 2, R_L$  connected from OUT to  $V_{DD} / 2, \overline{SHDN_{-}} = V_{DD}$  (MAX4245/MAX4247 only),  $T_A = +25^{\circ}C$ , unless otherwise noted.) (Note 1)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Gain-Bandwidth Product	GBW		1.0			MHz
Phase Margin	φм			70		degrees
Gain Margin	G <sub>M</sub>			20		dB
Slew Rate	SR			0.4		V/µs
Input Voltage-Noise Density	en	f = 10kHz		52		nV/√ <del>Hz</del>
Input Current-Noise Density	in	f = 10kHz		0.1		pA/√Hz
Capacitive-Load Stability	CLOAD	Ay = 1 (Note 3)		470	рF	
Shutdown Delay Time	t(SH)	(Note 2)		3		μs
Enable Delay Time	t(EN)	(Note 2)		4		μs
Power-On Time	ton			4		μs
Input Capacitance	CIN			2.5		рF
Total Harmonic Distortion	THD	$f = 10kHz$ , $V_{OUT} = 2Vp-p$ , $A_V = +1$ , $V_{DD} = +5.0V$ , Load = $100k\Omega$ to $V_{DD}/2$		0.01		%
Settling Time to 0.01%	ts	$V_{OUT} = 4V$ step, $V_{DD} = +5.0V$ , $A_V = +1$	$V_{OUT} = 4V \text{ step}, V_{DD} = +5.0V, A_V = +1$ 10			μs

### **ELECTRICAL CHARACTERISTICS**

 $(V_{DD} = +2.7V, V_{SS} = 0V, V_{CM} = 0V, V_{OUT} = V_{DD} / 2, R_L connected from OUT to V_{DD} / 2, $\overline{SHDN}_ = V_{DD} (MAX4245/MAX4247 only), T_A = -40°C to +125°C, unless otherwise noted.) (Note 1)$ 

PARAMETER	SYMBOL	CONDITIONS		TYP	MAX	UNITS
Supply Voltage Range	$V_{DD}$	Inferred from PSRR test	2.5		5.5	V
Supply Current (Per Amplifier)	I <sub>DD</sub>	$V_{DD} = +2.7V$			800	μΑ
Supply Current in Shutdown	ISHDN_	SHDN_ = V <sub>SS</sub> (Note 2)			1	μΑ
Input Offset Voltage	Vos	$V_{SS} \le V_{CM} \le V_{DD}$ (Note 4)			±3.0	mV
Input Offset Voltage Drift	TCVOS	$V_{SS} \le V_{CM} \le V_{DD}$ (Note 4)		±2		μV/°C
Input Bias Current	$I_{B}$	$V_{SS} \le V_{CM} \le V_{DD}$ (Note 4)			±100	nA
Input Offset Current	los	$V_{SS} \le V_{CM} \le V_{DD}$ (Note 4)			±10	nA
Input Common-Mode Voltage Range	V <sub>CM</sub>	Inferred from CMRR test (Note 4)	V <sub>SS</sub>		$V_{DD}$	V
Common-Mode Rejection Ratio	CMRR	$V_{SS} \le V_{CM} \le V_{DD}$ (Note 4) 60				dB
Power-Supply Rejection Ratio	PSRR	$2.5V \le V_{DD} \le 5.5V $ 70			dB	
Large-Signal Voltage Gain	Av	$V_{SS} + 0.2V \le V_{OUT} \le V_{DD} - 0.2V,$ $R_L = 2k\Omega$ 85				dB
Output Voltage Swing High	VoH	Specified as $V_{DD}$ - $V_{OUT}$ , $R_L = 2k\Omega$			90	mV
Output Voltage Swing Low	V <sub>OL</sub>	Specified as $V_{OUT}$ - $V_{SS}$ , $R_L = 2k\Omega$ 90		90	mV	
Output Leakage Current in Shutdown	I <sub>OUT(SH)</sub>	Device in Shutdown Mode ( $\overline{SHDN}$ = Vss), Vss $\leq$ Vout $\leq$ VDD (Note 3)		±1.0	μА	



## **ELECTRICAL CHARACTERISTICS (continued)**

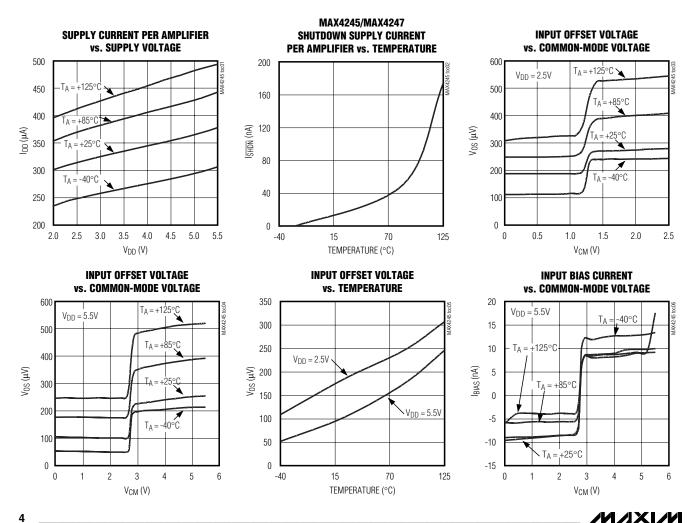
 $(V_{DD} = +2.7V, V_{SS} = 0V, V_{CM} = 0V, V_{OUT} = V_{DD} / 2, R_L connected from OUT to V_{DD} / 2, \overline{SHDN} = V_{DD} (MAX4245/MAX4247 only), T_A = -40°C to +125°C, unless otherwise noted.) (Note 1)$ 

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP MAX	UNITS
SHDN_ Logic Low	VIL	(Note 2)		$0.3 \times V_{DD}$	\ \
SHDN_ Logic High	VIH	(Note 2)	$0.7 \times V_{DD}$		V
SHDN_ Input Current	IL/IH	$V_{SS} \le \overline{SHDN} \le V_{DD}$ (Notes 2, 3)		100	nA

- Note 1: Specifications are 100% tested at T<sub>A</sub> = +25°C. All temperature limits are guaranteed by design.
- Note 2: Shutdown mode is only available in MAX4245 and MAX4247.
- Note 3: Guaranteed by design, not production tested.
- **Note 4:** For -40°C to +85°C, Input Common-Mode Range is  $V_{SS}$  0.1V  $\leq V_{CM} \leq V_{DD}$  + 0.1V.

## Typical Operating Characteristics

 $(V_{DD} = 2.7V, V_{SS} = V_{CM} = 0V, V_{OUT} = V_{DD} / 2$ , no load,  $T_A = +25$ °C, unless otherwise noted.)

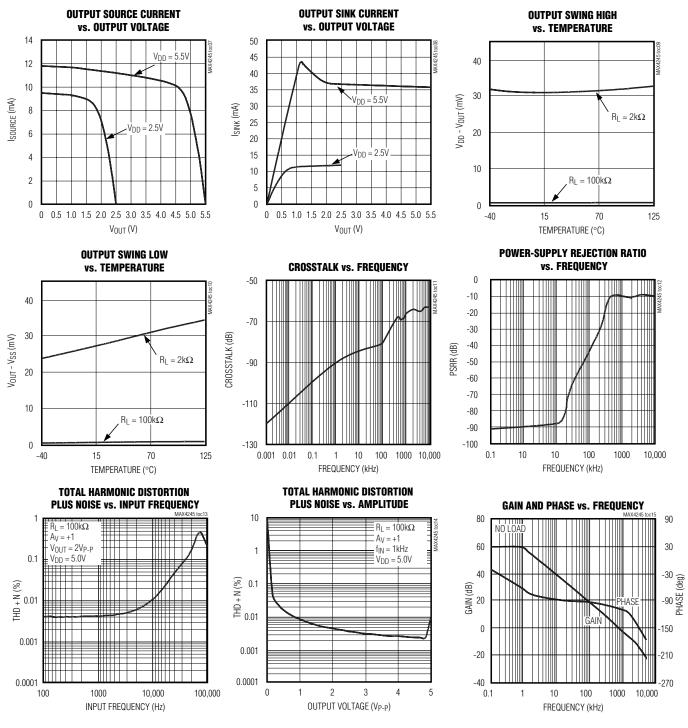


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# Ultra-Small, Rail-to-Rail I/O with Disable, Single-/Dual-Supply, Low-Power Op Amps

## Typical Operating Characteristics (continued)

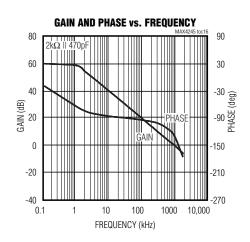
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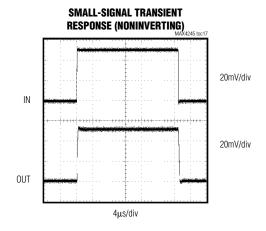


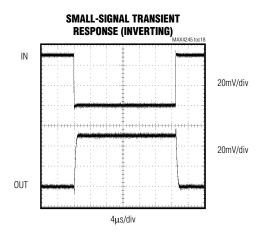
NIXIN

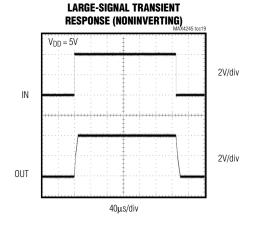
## Typical Operating Characteristics (continued)

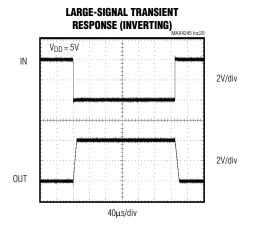
 $(V_{DD} = 2.7V, V_{SS} = V_{CM} = 0V, V_{OUT} = V_{DD} / 2$ , no load,  $T_A = +25$ °C, unless otherwise noted.)











6 \_\_\_\_\_\_ NIXI/N

### **Pin Description**

PIN		PIN		EUNCTION
MAX4245	MAX4246	MAX4247	NAME	FUNCTION
1	_	_	IN+	Noninverting Input
2	4	4	V <sub>SS</sub>	Ground or Negative Supply
3	_	_	IN-	Inverting Input
4	_	_	OUT	Amplifier Output
5	_	_	SHDN	Shutdown
6	8	10	$V_{DD}$	Positive Supply
_	1	1	OUTA	Amplifier Output Channel A
_	2	2	INA-	Inverting Input Channel A
_	3	3	INA+	Noninverting Input Channel A
_	5	7	INB+	Noninverting Input Channel B
_	6	8	INB-	Inverting Input Channel B
_	7	9	OUTB	Amplifier Output Channel B
_	_	5	SHDNA	Shutdown Channel A
_	_	6	SHDNB	Shutdown Channel B

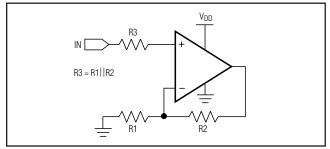


Figure 1a. Minimizing Offset Error Due to Input Bias Current (Noninverting)

## **Detailed Description**

#### Rail-to-Rail Input Stage

The MAX4245/MAX4246/MAX4247 have rail-to-rail input and output stages that are specifically designed for low-voltage, single-supply operation. The input stage consists of composite NPN and PNP differential stages, which operate together to provide a common-mode range extending to both supply rails. The crossover region of these two pairs occurs halfway between VDD and Vss. The input offset voltage is typically ±400µV. Low-operating supply voltage, low supply current and rail-to-rail outputs make this family of operational amplifiers an excellent choice for precision or general-purpose, low-voltage, battery-powered systems.

Since the input stage consists of NPN and PNP pairs, the input bias current changes polarity as the common-

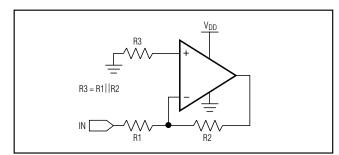


Figure 1b. Minimizing Offset Error Due to Input Bias Current (Inverting)

mode voltage passes through the crossover region. Match the effective impedance seen by each input to reduce the offset error caused by input bias currents flowing through external source impedance (Figures 1a and 1b).

The combination of high-source impedance plus input capacitance (amplifier input capacitance plus stray capacitance) creates a parasitic pole that can produce an underdamped signal response. Reducing input capacitance or placing a small capacitor across the feedback resistor improves response in this case.

The MAX4245/MAX4246/MAX4247 family's inputs are protected from large differential input voltages by internal  $5.3k\Omega$  series resistors and back-to-back triple-diode stacks across the inputs (Figure 2). For differential-input voltages much less than 2.1V (triple-diode drop),

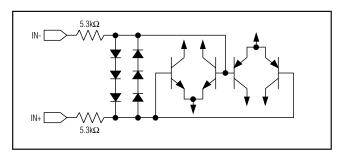


Figure 2. Input Protection Circuit

input resistance is typically  $4M\Omega$ . For differential voltages greater than 2.1V, input resistance is around 10.6k $\Omega$ , and the input bias current can be approximated by the following equation:

$$IB = (V_{DIFF} - 2.1V) / 10.6k\Omega$$

In the region where the differential input voltage approaches 2.1V, the input resistance decreases exponentially from  $4M\Omega$  to  $10.6k\Omega$  as the diodes begin to conduct. It follows that the bias current increases with the same curve.

In unity-gain configuration, high slew-rate input signals may capacitively couple to the output through the triple-diode stacks.

### Rail-to-Rail Output Stage

The MAX4245/MAX4246/MAX4247 can drive a  $2k\Omega$  load and still typically swing within 35mV of the supply rails. Figure 3 shows the output voltage swing of the MAX4245 configured with Ay = -1V/V.

## Applications Information

### **Power-Supply Considerations**

The MAX4245/MAX4246/MAX4247 operate from a single  $\pm 2.5V$  to  $\pm 5.5V$  supply (or dual  $\pm 1.25V$  to  $\pm 2.75V$  supplies) and consume only  $\pm 320\mu$ A of supply current per amplifier. A 90dB power-supply rejection ratio allows the amplifiers to be powered directly off a decaying battery voltage, simplifying design and extending battery life.

### Power-Up

The MAX4245/MAX4246/MAX4247 output typically settles within 4µs after power-up. Figure 4 shows the output voltage on power-up and power-down.

#### **Shutdown Mode**

The MAX4245/MAX4247 feature a low-power shutdown mode. When SHDN\_ is pulled low, the supply current drops to 50nA per amplifier, the amplifier is disabled, and the output enters a high-impedance state. Pulling

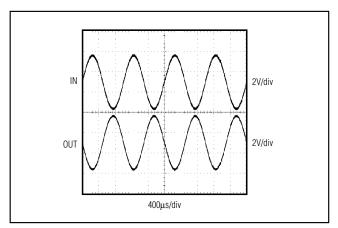


Figure 3. Rail-to-Rail Input/Output Voltage Range

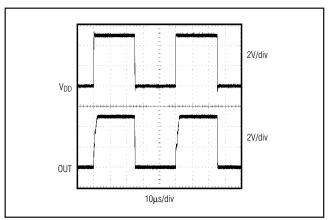


Figure 4. Power-Up/Power-Down Waveform

SHDN\_ high enables the amplifier. Figure 5 shows the MAX4245/MAX4247's shutdown waveform.

Due to the output leakage currents of three-state devices and the small internal pullup current for SHDN\_, do not let the SHDN\_ float. Floating SHDN\_ may result in indeterminate logic levels, and could adversely affect op amp operation. The logic threshold for SHDN\_ is referred to Vss. When using dual supplies, pull SHDN\_ to Vss, not GND, to shut down the op amp.

### **Driving Capacitive Loads**

The MAX4245/MAX4246/MAX4247 are unity-gain stable for loads up to 470pF. Applications that require greater capacitive drive capability should use an isolation resistor between the output and the capacitive load

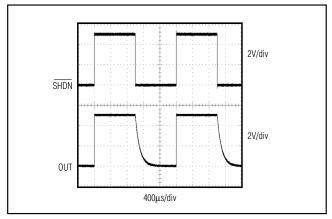


Figure 5. Shutdown Waveform

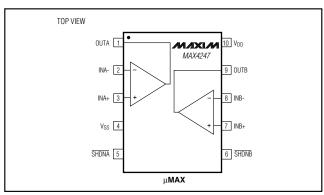
(Figures 6a, 6b, 6c). Note that this alternative results in a loss of gain accuracy because  $R_{\rm ISO}$  forms a voltage divider with the  $R_{\rm LOAD}$ .

### **Power-Supply Bypassing and Layout**

The MAX4245/MAX4246/MAX4247 family operates from either a single  $\pm 2.5 \text{V}$  to  $\pm 5.5 \text{V}$  supply or dual  $\pm 1.25 \text{V}$  to  $\pm 2.75 \text{V}$  supplies. For single-supply operation, bypass the power supply with a 100nF capacitor to Vss (in this case GND). For dual-supply operation, both the VDD and the Vss supplies should be bypassed to ground with separate 100nF capacitors.

Good PC board layout techniques optimize performance by decreasing the amount of stray capacitance at the op amp's inputs and output. To decrease stray capacitance, minimize trace lengths and widths by placing external components as close to the device as possible. Use surface-mount components when possible.

## Pin Configurations (continued)



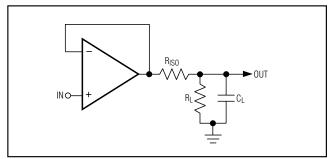


Figure 6a. Using a Resistor to Isolate a Capacitive Load from the Op Amp

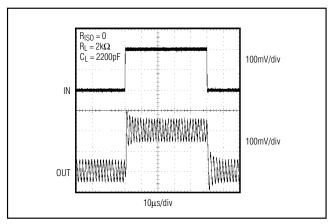


Figure 6b. Pulse Response Without Isolating Resistor

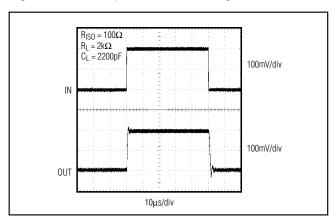


Figure 6c. Pulse Response With Isolating Resistor

## \_Chip Information

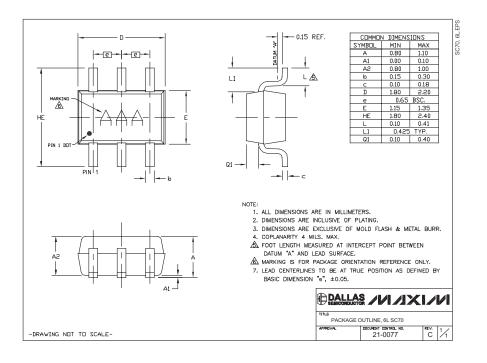
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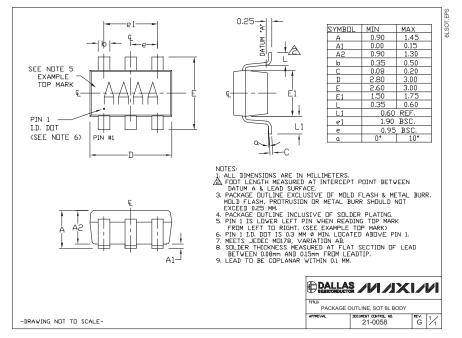
MAX4246/MAX4247 TRANSISTOR COUNT: 414

PROCESS: BICMOS

### **Package Information**

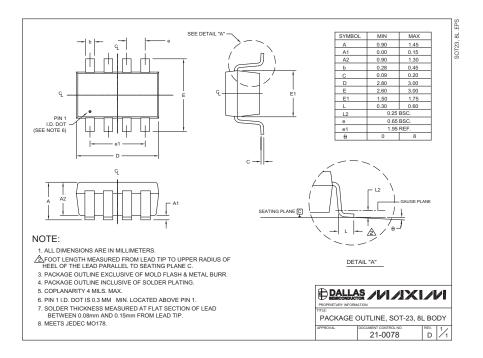
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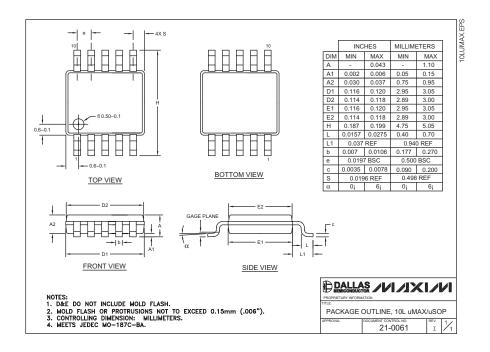




## **Package Information (continued)**

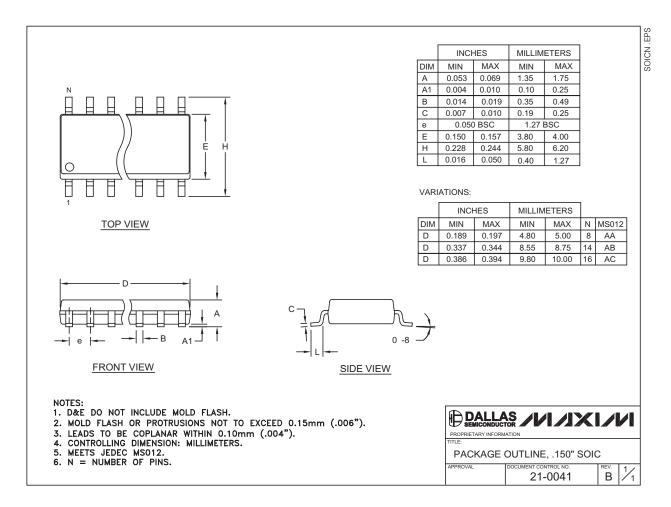
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### **Package Information (continued)**

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